

何玄

助理研究员

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教育背景

2017年02月~2019年01月台湾清华大学,博士.

2013年06月~2015年06月Amity University, 印度, 硕士.

2009年06月~2011年06月德里大学,印度,硕士.

2005年12月~2008年12月Kuvempu University, 印度, 学士.

工作经历

2019年04月~至今助理研究员,上海交通大学,中美物流研究院.

2019年09月~2020年04月讲师(博士后),上海交通大学,中美物流研究院.

2019年02月~2019年08月兼职助理教授,台湾清华大学.

2019年04月~2019年08月科技部博士后研究员,台湾.

2018 年 07 月~ 2018 年 08 月 台湾清华大学讲师.

2016年02月~2017年02月台湾清华大学研究助理.

2012 年 01 月~ 2013 年 07 月 工程师, 欧创 (Altran) 咨询公司(Aricent), 诺基亚网络 (Nokia Networks), 芬兰.

研究方向

新兴技术管理、知识产权分析、工业沉浸式技术、工业 4.0、应用设计和开发、智能供应 链和可持续发展.

科研项目

计划项目负责人:

1. Intelligent digital supply chain orchestration and sustainability,中国博士后科学基金会 (2019 年度博士后国际交流引进计划),2019 年—2021 年,主持.

计划项目成员:

- 1. 虚拟实境在医疗应用上的探索, 长**庚纪念医院 精神科系**, 角色: 项目协调员和开发团队负责人, 项目负责人: 張瑞芬 特聘教授, 2019 年—2021年.
- 2. 智慧型优势比对, **华城电机股份有限公司**, 角色: 概念和开发团队成员的初步证明, 项目负责人: 張瑞芬 特聘教授, 2019 年—2020 年.
- 3. 智慧问答与对话技术专利说明书阅读及分析服务, 台湾资讯工业策进会,角色: 项目团队成员, 项目负责人: 張瑞芬 特聘教授, 2018 年.
- 4. OBM 国际品牌资产价创研究, 台湾经济研究院, 角色: 项目组组长, 项目负责人: 張力元博士, 2017年.
- 5. 发展智能化智财布局主题探索-以非监督式机器学习方法为基, 科技部台湾, 角色: 项目成员, 项目负责人: 張瑞芬 特聘教授, 2016年-2018年.

代表性论文专著

期刊论文:(*通讯作者)

- 1. Trappey, A. J.*, Trappey, C. V., Chang, C. M., Shih, X. Y., Govindarajan, U. H., Gupta, N., & Su, I. A. (2020). Behavioral Therapy for Phobias Using Immersive Virtual Reality Technology. 中國機械工程學刊第, 四十一卷第二期第 131~140 頁
- 2. Raut, R. D., Gotmare, A., Narkhede, B. E., Govindarajan, U. H.*, & Bokade, S. U. (2020). Enabling technologies for Industry 4.0 manufacturing and supply chain: concepts, current status, and adoption challenges. IEEE Engineering Management Review (Early Access, DOI: 10.1109/EMR.2020.2987884).
- 3. Trappey, A. J., Trappey, C. V., Govindarajan, U. H.*, & Sun, J. J. (2019). Patent Value Analysis Using Deep Learning Models The Case of IoT Technology Mining for Manufacturing Industries. IEEE Transactions on Engineering Management (Early Access, DOI: 10.1109/TEM.2019.2957842).
- 4. Govindarajan, U. H., Trappey, A. J., & Trappey, C. V. (2019). Intelligent Collaborative Patent Mining Using Excessive Topic Generation. Advanced Engineering Informatics, Vol. 42, pp. 100955.
- 5. Govindarajan, U. H.*, Sheu, D. D., & Mann, D. (2019). Review of Systematic Software Innovation Using TRIZ. International Journal of Systematic Innovation, vol. 5, pp. 72-90, ISSN: 2077-7973.
- 6. Trappey, A. J., Trappey, C. V., Govindarajan, U. H.*, & Jhuang, A. C. (2018). Construction and Validation of an Ontology-based Technology Function Matrix: Text Mining of Cyber Physical System Patent Portfolios. World Patent Information, vol. 55, pp. 19-24.
- 7. Govindarajan, U. H., Trappey, A. J., & Trappey, C. V. (2018). Immersive Technology for Human Centric Cyber Physical Systems in Complex Manufacturing Processes: A Comprehensive Overview of Global Patent Profile Using Collective Intelligence. Complexity.

- 8. Trappey, A. J., Trappey, C. V., Govindarajan, U. H., Sun, J. J., & Chuang, A. C. (2016). A Review of Technology Standards and Patent Portfolios for Enabling Cyber-Physical Systems in Advanced Manufacturing. IEEE Access, vol. 4, pp. 7356-7382.
- 9. Trappey, A. J., Trappey, C. V., Govindarajan, U. H., Chuang, A. C., & Sun, J. J. (2016). A Review of Essential Standards and Patent Landscapes for The Internet of Things: A Key Enabler for Industry 4.0. Advanced Engineering Informatics, vol. 33, pp. 208-229.

会议论文:(* 通讯作者)

- 1. Yao, M. J., Govindarajan, U. H.*, & Zhang, D. (2020). Augmented Interface Assisted Openshelf FMCG Decision Support. In Proceedings of the 24th International Conference on Computer Supported Cooperative Work in Design, Dalian, China [录取通知书].
- 2. Raut, R. D., Lee, C. H., Govindarajan, U. H.*, & Zhang, D. (2020). An Augmented Reality System for Waste Segregation Assistance. In Proceedings of the 24th International Conference on Computer Supported Cooperative Work in Design, Dalian, China [录取通知书].
- 3. Trappey, A. J., Trappey, C. V., Govindarajan, U. H.*, Chang, C. M., Khera, N., & Kuo, R. T. (2020). A Treatment Outline for Driving Related Post-Traumatic Stress Disorder Using Virtual Reality Exposure Therapy. In Proceedings of the 24th International Conference on Computer Supported Cooperative Work in Design, Dalian, China [录取通知书].
- 4. Narkhede, B., Raut, R.*, Narwane, V., Govindarajan, U. H., Siddavatam, I., & Samant, A. (2020). Cloud-Based Manufacturing Service Selection Based on Simulation Approaches. In Proceedings of the 24th International Conference on Computer Supported Cooperative Work in Design, Dalian, China [录取通知书].
- 5. Raut, R., Priyadarshinee, P., Narkhede, B.*, & Govindarajan, U. H. (2020). Instrument Development for IoT Adoption. In Proceedings of the 24th International Conference on Computer Supported Cooperative Work in Design, Dalian, China [录取通知书].

- 6. Trappey, A. J., Trappey, C. V., & Govindarajan, U. H.* (2019). Knowledge Extraction of RfQ Engineering Documents for Smart Manufacturing. In Proceedings of the 22nd International Conference on Advances in Materials & Processing Technologies, Taipei, Taiwan, China.
- 7. Hong, N. J., Govindarajan, U. H., & Trappey, A. J. (2019). Comprehensive Technology Function Product Matrix for Intelligent Chatbot Patent Mining. In Proceedings of the 2019 IEEE International Conference on Systems, Man, and Cybernetics, Bari, Italy.
- 8. Govindarajan, U. H.*, Trappey, A. J., & Trappey, C. V., (2019). 360° Technology as a Gateway for Immersive Psychotherapy Applications: An Intelligent Patent Mining Analysis. In Proceedings of the 15th International Conference on Data Science (ICDATA), Nevada, USA.
- 9. Govindarajan, U. H.*, Trappey, A. J., Trappey, C. V., Yeh, L. C., & Bafila, A. S. (2018). Excessive Topic Generation: A Pre-processing Method for Collective Intelligence and Relationship Mining. In Proceedings of the 19th Asia Pacific Industrial Engineering & Management Systems Conference (APIEMS), Hong Kong, China.
- 10. Trappey, A. J., Trappey, C. V., Govindarajan, U. H.*, & Sharma, A. (2018). Conversational Service Bot Specifications for Advanced Manufacturing Applications. In Proceedings of the 2018 IEEE International Conference on Advanced Manufacturing (ICAM), Yunlin, Taiwan, China [最佳论文奖].
- 11. Govindarajan, U. H.*, Trappey, A. J., & Trappey, C. V. (2018). Topics and Trends in Industrial Internet of Things (IIoT)- A 10 Year Patent Data Outlook. In Proceedings of the 29th Annual Conference of the International Information Management Association (IIMA), Texas, USA.
- 12. Trappey, A. J., Trappey, C. V., Govindarajan, U. H.*, & Sun, J. J. (2018). Patent Quality Estimation Using Machine Learning An Industrial Internet of Things Empirical Study. In Proceedings of the 2018 International Symposium on Semiconductor Manufacturing Intelligence (ISMI), Hsinchu, Taiwan, China. [最佳论文奖入围].

- 13. Trappey, A. J., Trappey, C. V., Govindarajan, U. H., & Gupta, A. (2017). OBM-centric Digital Marketing Development for High-tech Services A Case Study. In Proceedings of the 8th International Conference on Internet Technologies & Society (ITS), Sydney, Australia.
- 14. Govindarajan, U. H.*, Trappey, A. J., & Kumar, G. (2017). Latent Dirichlet Allocation modeling for CPS Patent Topic Discovery. In Proceedings of the 1st International Conference on Industrial, Enterprise, and System Engineering (ICoIESE), Bandung, Indonesia.
- 15. Jhuang, A. C., Sun, J. J., Trappey, A. J., Trappey, C. V., & Govindarajan, U. H. (2017). Computer Supported Technology Function Matrix Construction for Patent Data Analytics. In Proceedings of the 2017 Computer Supported Cooperative Work in Design (CSCWD), Wellington, New Zealand.
- 16. Govindarajan, U. H.*, Trappey, A. J., & Trappey, C. V. (2016). Investigating Technology and Patent Portfolio of Lens-Less Cameras in the Context of Industry 4.0. In Proceedings of the 17th Asia Pacific Industrial Engineering & Management Systems Conference (APIEMS), Taipei, Taiwan, China. [最佳论文奖入围].

Teaching

10810IEEM316000: 资料库管理系统 (Data Base Management System).

10730IEEM580100: 学术写作与报告技巧 (Academic Writing and Presentation Skills).

10620IEEM214000: 程式设计与应用 (Programming Design and Application).

10630IEEM314000: 资料结构 (Data Structure).

学术兼职

会议编辑委员会成员:

2020 年 04 月~至今 Associate Editor(副主编), 国际工程技术学会 (IET) Collaborative Intelligent Manufacturing Journal.

2020 年 特别会议嘉宾编辑及核心委员, IEEE International Conference on Computer Supported Cooperative Work in Design (IEEE CSCWD 2020).

主持会议:

2019年08月会议主席 (Health Informatics & Applications Track), International Conference on Artificial Intelligence (ICAI 2019), Nevada, USA.

2018年12月会议主席 (Artificial Intelligence Track), University of Hong Kong, China.

主题演讲:

2019 年 11 月 Seize this opportunity: The rise of immersive technologies, 德里大学, 新德里, 印度.

特邀嘉宾讲座:

2019 年 10 月 Towards Industry 4.0 and its application use cases, National Institute of Industrial Engineering, 孟买, 印度.

2019 年 04 月 Intelligent conversational interface applications, National Institute of Industrial Engineering, 孟买, 印度.

2018 年 10 月 Identifying gaps in product continuum, 德里大学, 新德里, 印度.

2018年05月 Analytics for smart future business, National Sun Yat-Sen University, 台湾, 中国.

2018 年 03 月 Industry 4.0 patent analytics, National Chiao Tung University, 台湾, 中国.

2017年12月 A digital marketing outline, National Chiao Tung University, 台湾, 中国.

2016年08月 Lensless camera technology and essential patents, University of Fiji, 斐济.

审稿成员:

- 2020年~至今 IEEE Engineering Management Review (SCI).
- 2020年~至今IEEE Access (SCI).
- 2020年~至今 Engineering Journal of the 中国工程院 (SCIE).
- 2019年~至今 IEEE Transactions on Engineering Management (SCI).
- 2019 年 ~ 至今 Business Strategy and The Environment (SSCI).
- 2019 年~ 至今 The Journal of Enterprise Information Management (SSCI).
- 2017年~至今World Patent Information (SNIP).
- 2017年~至今 IEEE Transactions on Systems, Man, and Cybernetics (SCI).
- 2016年~至今 Advanced Engineering Informatics (SCI).

荣誉奖励

- 1. Outstanding conference proceeding paper cash award, 台湾清华大学, 2019 年.
- 2. Certificate of appreciation for internship program management, College of Engineering 台湾清华大学, 2019 年.
- 3. IEEE best research paper award, IEEE International Conference on Advanced Manufacturing (ICAM), 2018 年.
- 4. Best paper award finalist, International Symposium on Semiconductor Manufacturing Intelligence (ISMI), 2018 年.
- 5. Presidents doctoral scholarship, 台湾清华大学, 2017 年 和 2018 年.
- 6. Best paper award finalist, Asia Pacific Industrial Engineering & Management Systems Conference (APIEMS), 2016 年.

- 7. Shri. Baljit Shastri award for overall excellence in Engineering, Amity University, 2015年.
- 8. Global engineering leadership scholarship, 台湾清华大学, 2014 年.